

SPECIFICATION SHEET

MHZ SMD CERAMIC RESONATOR CASE 3213 CH SERIES

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SPECIFICATION SHEET NO.	R1018- CH11M00000S033		
ORIGINAL MFG/PART NO	TGS Crystals/CRTE 11.0MG-33 TLH/ZTTCE11.0MG33		
DATE	Oct. 18, 2024		
REVISION	A2	Updated With Most Recent Data	
DESCRIPTION AND	MHz SMD Ceramic Resonator, 3 Pads, CH Series		
	Case 322	L3, Dimension L3.2*W1.3*H1.0mm	
MAIN PARAMETRICS	11.0MHz, Frequency Accuracy \pm 0.5%; Built-in Capacitance 33pF		
	Operating Temp. Range -25°C ~+85°C;		
	Reflow Profile Condition 260 °C Max.		
	Package in Tape/Reel, 3000pcs/Reel		
	REACH/RoHS/RoHS III Compliant, RoHS Annex III lead Exemption		
	(Exempt per RoHS EU 2015/863)		
CUSTOMER			
CUSTOMER PART NUMBER			
CROSS REF. PART NUMBER			
ΜΕΜΟ			

VENDOR APPROVE Issued/Checked/Approved Date: Oct. 18, 2024

 CUSTOMER APPROVE

 Date:

 10/18/2024
 1



PART CODE: CH11M00000S033 MHZ SMD CERAMIC RESONATOR CASE 3213 CH SERIES

MAIN FEATURE

- MHz SMD Ceramic Resonator, 3 pads, Case 3213,
- Case Dimension L3.2*W1.3*H1.0mm
- Low Cost And Short Shipment
- Cross More Competitors Part
- Built-in Capacitance
- Reflow Profile Condition 260 °C Max.
- REACH/RoHS/RoHS III compliant, RoHS Annex III lead Exemption

(Exempt per RoHS EU 2015/863)

APPLICATION

- Communication Electronics and More
- Bluetooth, Wireless Communication Set

HOW TO ORDER

• Please follow up part code guide and indicate part code when you order or RFQ.

PART CODE GUIDE

CODE	NAME	KEY SPECIFICATION OPTION
СН	Product Series	MHz SMD Ceramic Resonator, 3 pads, Case 3213 Dimension L3.2*W1.3*H1.0mm
11M0	Frequency Range	11M0: 11.000MHz
0000	Internal Control	Letter or Digits (A~Z, a~z or 1~9)
S	SMD Type Package	Tape/Reel
033	Special Parametric	Letter or Digits (A~Z, a~z or 1~9)
- XX	Suffix	Blank: N/A XX: Internal Control Code, Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters

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Image shown is a representation only. Exact specifications should be obtained from the product dimension.

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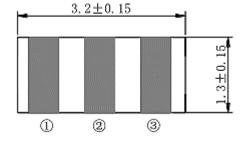
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DIMENSION (Unit: mm)

Case 3213, 3 Pads

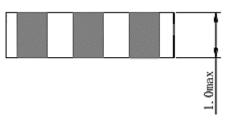
L3.2*W1.3*H1.0mm

Top View



Marking Frequency Range + QC Code

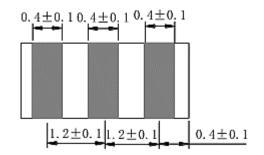
 ${\tt Connection:} \ \textcircled{1} \ {\tt Input} \ \textcircled{2} \ {\tt Ground} \ \textcircled{3} \ {\tt Output}$





Bottom View

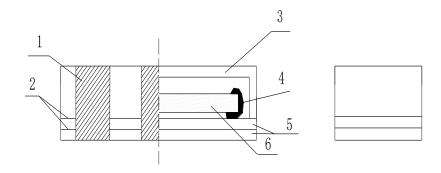
Side View





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STRUCTURE

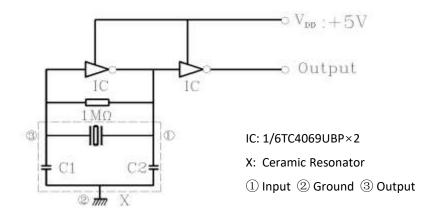


NO.	COMPONENTS	MATERIALS
1	Outer Electrodes	Top and Bottom Electrodes Ag + Ni (under plating) + Sn(over plating) Side Electrodes Ni + Cu + Ag(under plating)+Sn(over plating)
2	Glue	Epoxy Resin
3	Cover	Dielectric Material
4	Conductive Adhesive	Ag + Epoxy Resin
5	Base	Dielectric Material
6	Ceramic Element	Piezoelectric Ceramics (PZT) +Ag



MEASUREMENT

- Parts shall be tested under the condition (Temp.: 20±15°C,Humidity 65±20% R.H.) unless the standard condition (Temp.: 25±3 °C, Humidity : 65±10% R.H.) is regulated to measure.
- Measuring Circuit



GENERAL ELECTRICAL CHARACTERISTICS AND RATING- FOR DIFFERENT PART CODE- Ta = 25°C

PARAMETER	SYMBOLS	VALUE	UNITS	CONDITION
Withstanding Voltage	-	50	V	@DC, 1 min.
Insulation Resistance	Ri	500 Min.	mΩ	@10V, 1min.
Operating Temperature Range	ιT	-25 to +85	°C	
Storage Temperature Range	Т ѕтб	-55 to +85	°C	
Rating Voltage	U r	6	V DC	
		15	V р-р	
Temperature Coefficient of Oscillation Frequency		±0.2 Max.	%	Oscillation Frequency drift, -25℃ ~ +85℃
Oscillation Frequency Aging Rate (10 Years) *		±0.1 Max.		From initial value

Note: * : Components shall be left in a chamber of +85 \pm 2 °C for 1000 hours, then measured after leaving in natural condition for 1 hours.

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ELECTRICAL CHARACTERISTICS - FOR DIFFERENT PART CODE

PART CODE	CENTER FREQUENCY (F0)	FREQUENCY ACCURACY	MAX.RESONANT IMPEDANCE R0	BUILT-IN CAPACITANCE C1, C2	IC MODEL NO.
	MHz	%	Ω	pF	
CH8M0000005015	8.000	±0.5	40	15 (1±20%)	1/6TC4069UBPx2
CH8M000000S033	8.000	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH8M192000S033	8.192	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH8M388000S010	8.388	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH8M388000S033	8.388	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH9M000000S010	9.000	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH9M210000S010	9.210	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH9M830000S010	9.830	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH10M00000S010	10.00	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH10M00000S033	10.00	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH11M00000S010	11.00	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH11M00000S033	11.00	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH12M00000S010	12.00	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH12M00000S033	12.00	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH12M28800S010	12.288	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH12M28800S033	12.288	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH12M50000S010	12.50	±0.5	40	10 (1±20%)	1/6TC4069UBPx2
CH12M50000S033	12.50	±0.5	40	33 (1±20%)	1/6TC4069UBPx2
CH13M00000S010	13.00	±0.5	40	10 (1±20%)	1/6TC4069UBPx2

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PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

TEST ITEMS	TEST METHOD AND CONDITIONS	REQUIREMENT
Humidity	Keep the resonator at 40°C \pm 2°C and 90%-95% RH for 96h. Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1.
High Temperature	Subject the resonator to $85^{\circ}C \pm 2^{\circ}C$ for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Low Temperature	Subject the resonator to -55°C \pm 2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h. Temp.: −25±3°C, Time: 30±3 min ; Temp.: 85±3°C, Time: 30±3 min.	It shall fulfill the specifications in Table 1.
Vibration	Subject the resonator to vibration for 2h each in x_x y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1.
Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1.
Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement.	It shall fulfill the specifications in Table 1.
Solderability	Dipped in 245°C \pm 5°C solder bath for 3s \pm 0.5 s with rosin flux (25wt% ethanol solution.). see <i>Suggested Reflow Profile</i>	The terminals shall be at least 95% covered by solder.
Board Bending	Mount on a glass-epoxy board(width =40mm, thickness=1.6mm),then bend it to 1mm displacement(velocity= 1mm/s) and keep it for 5s.	Mechanical damage such as break shall not occur

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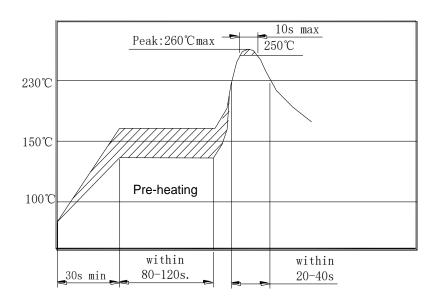


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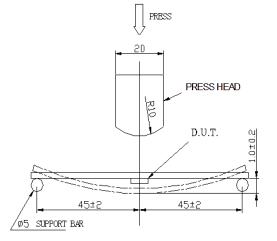
Table 1

TEST ITEMS	CHARACTERISTICS AFTER TEST		
	VALUE	UNITS	
Oscillation Frequency Change \triangle Fosc/Fosc	±0.3 Max	%	
Resonant Impedance $ riangle$ Ro	40 Max.	Ω	
Note: The limits in the above table are referenced to the initial measurements.			

Soldering Test



Board Bending

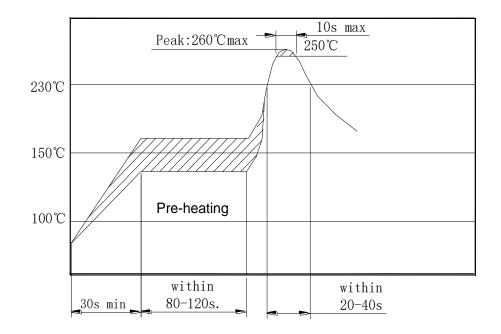


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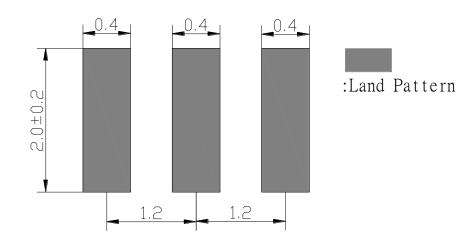


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SUGGESTED REFLOW PROFILE (For Reference Only)



RECOMMENDED LAND PATTERN (Unit: mm)

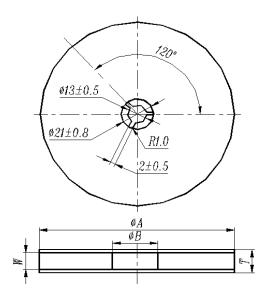


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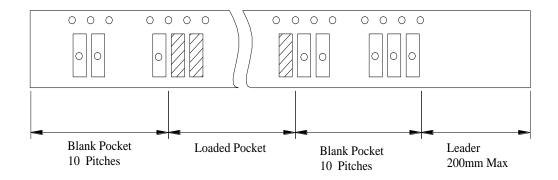
PART CODE: **CH11M00000S033** MHZ SMD CERAMIC RESONATOR CASE 3213 CH SERIES

TPAE/REEL DIMENSIONS (Unit: mm)

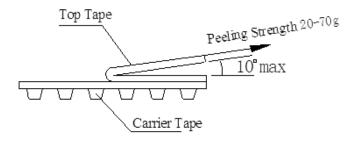


CODE	DIMENSION
фА	180±3.0
фВ	60 Min.
W	8.4 Min.
т	12.4 Max.
Qty. Per Reel	3000pcs
Carrier Tape Size	8

PACKING METHOD SKETCH MAP



TEST CONDITION OF PEELING STRENGTH



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CAUTION

- Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.
- Do not clean or wash the component for it is not hermetically sealed.
- Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
- Don't be close to fire.
- This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit
- Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solder-ability or rusty. Please confirm solder-ability and characteristics for the products regularly.
- Exposure components under soldering condition that is exceeding our recommendation will increase the failure dangerous.
- Please contact us before using the product as automobile electronic component.
- Please return one of these specifications after your signature of acceptance.
- When something gets doubtful with this specifications, we shall jointly work to get an agreement.
- For questions on technology, prices and delivery, please contact our sales offices or e-mail:

sales@NextGenComponent.com .

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IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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